

Photocouplers Photorelay

TLP221AF

1. Applications

- · Mechanical relay replacements
- · Security Systems
- · Measuring Instruments
- Factory Automation (FA)
- · Amusement Equipment
- · Smart Meters
- · Electricity Meters

2. General

The TLP221AF photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 4-pin DIP package. It provides an isolation voltage of 5000 Vrms, making it suitable for applications that require reinforced insulation.

3. Features

- (1) Normally open (1-Form-A)
- (2) OFF-state output terminal voltage: 40 V (min)
- (3) Trigger LED current: 2 mA (max)
- (4) ON-state current: 2.0 A (max)
- (5) ON-state resistance: $100 \text{ m}\Omega \text{ (max, t < 1s)}$
- (6) ON-state resistance: 150 mΩ (max, Continuous)
- (7) Isolation voltage: 5000 Vrms (min)
- (8) Safety standards

UL-recognized: UL 1577, File No.E67349

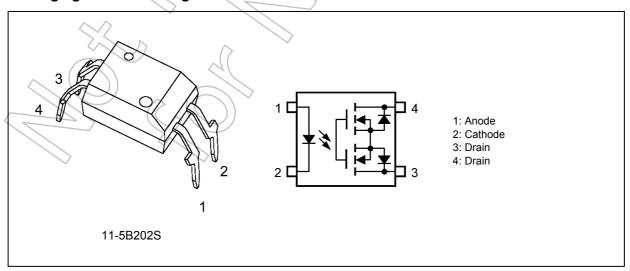
cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN 60747-5-5 (Note 1)

CQC-approved: GB4943.1, GB8898 Japan Factory

Note 1: When a VDE approved type is needed, please designate the Option (D4).

4. Packaging and Pin Configuration



Start of commercial production

2012-01



5. Internal Circuit

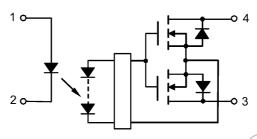


Fig. 5.1 Internal Circuit

6. Mechanical Parameters

Characteristics	7.62-mm Pitch TLP221A	10.16-mm Pitch TLP221AF	Unit
Creepage distances	7.0 (min)	8.0 (min)	mm
Clearance distances	7.0 (min)	8.0 (min)	
Internal isolation thickness	0.4 (min)	0.4 (min)	(\langle / \rangle)

7. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit
LED	Input forward current	(F (7)		30	mA
	Input forward current derating (T _a ≥ 25 °C)	ΔΙ _Γ /ΔΤ _α))	-0.3	mA/°C
	Input forward current (pulsed) (100 µs pulse, 100 pps)	IFR		1	Α
	Input reverse voltage	V _R		5	V
	Input power dissipation	Po		50	mW
	Input power dissipation derating $(T_a \ge 25 \text{ °C})$	$\Delta P_D/\Delta T_a$		-0.5	mW/°C
	Junction temperature	Tj		125	°C
Detector	OFF-state output terminal voltage	V _{OFF}		40	V
	ON-state current	I _{ON}		2.0	Α
	ON-state current derating (T _a ≥ 25 °C)	Δl _{ON} /ΔT _a		-20	mA/°C
	ON-state current (pulsed) (t = 100 ms, duty = 1/10)	I _{ONP}		6.0	Α
	Output power dissipation	Po		500	mW
	Output power dissipation derating (T _a ≥ 25 °C)	$\Delta P_O/\Delta T_a$		-5.0	mW/°C
	Junction temperature	Tj		125	°C
Common	Storage temperature	T _{stg}		-55 to 125	°C
	Operating temperature	T _{opr}		-40 to 85	°C
_	Lead soldering temperature (10 s)	T _{sol}		260	°C
	Isolation voltage (AC, 60 s, R.H. ≤ 60 %)	BV _S	(Note 1)	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.



8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V_{DD}		_	_	32	V
Input forward current	I _F		3	5	15	mA
ON-state current	I _{ON}	4	/		2.0	Α
Operating temperature	T _{opr}		-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

9. Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.45	1.63	1.75	V
	Input reverse current	I _R		V _R = 5 V		4	20	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_ <	40		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 40 V	-()+	1	μΑ
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	1	300	/ –	pF

10. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		T _{ON} = 1.0 A))—	0.3	2	mA
Return LED current	I _{FC}	4	I _{OFF} = 10 μA	0.1	_		mA
ON-state resistance	R _{ON}		$I_{ON} = 2.0 \text{ A}, I_F = 5 \text{ mA}, t < 1 \text{ s}$	_	60	100	mΩ
		(Note 1)	I_{ON} = 2.0 A, I_F = 5 mA, Continuous		90	150	

Note 1: Thermally saturated state.

11. Isolation Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _{\$} = 0 V, f = 1 MHz		0.8		pF
Isolation resistance	R_s	(Note 1)	V _S = 500 V, R.H. ≤ 60 %	1012	1014	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	5000			Vrms

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.



12. Switching Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t _{ON}		See Fig. 12.1.	_	2	5	ms
Turn-off time	t _{OFF}		$R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$	_	0.3	1	

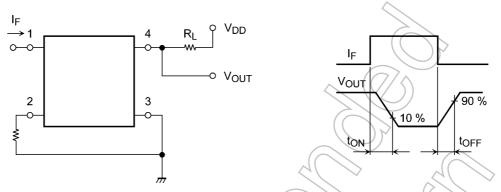


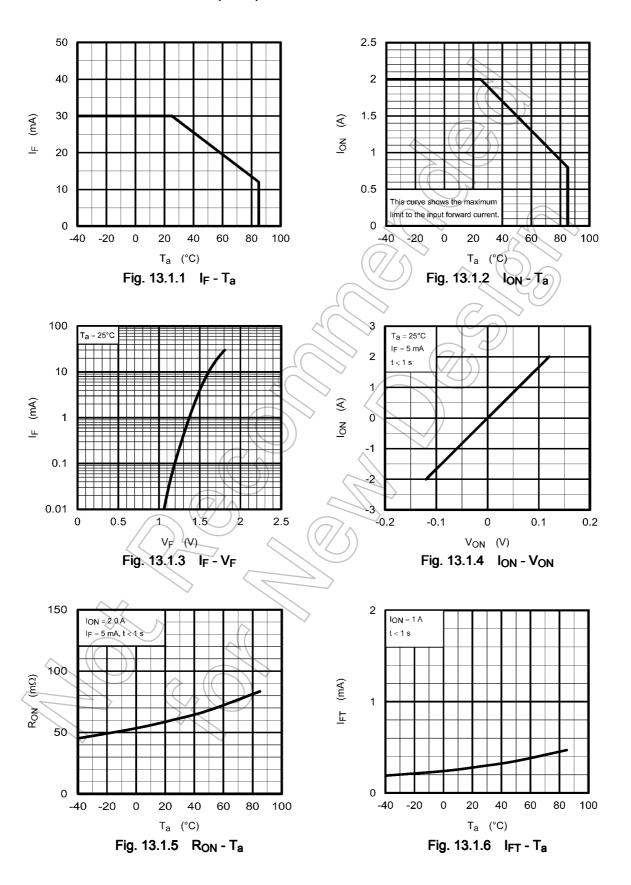
Fig. 12.1 Switching Time Test Circuit and Waveform



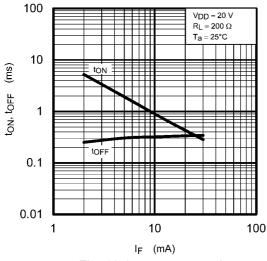


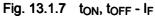
13. Characteristics Curves

13.1. Characteristics Curves (Note)









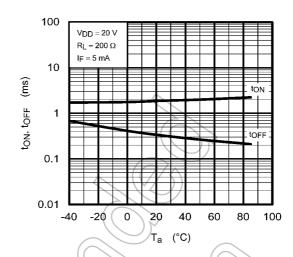
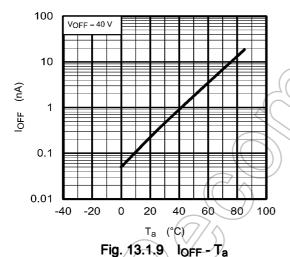


Fig. 13.1.8 ton, toff - Ta



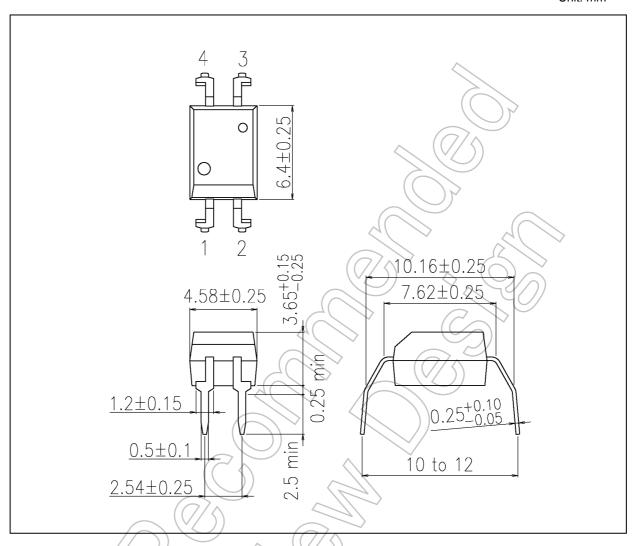
Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



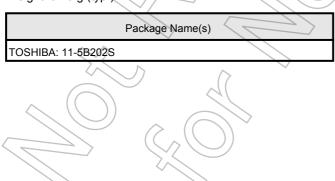


Package Dimensions

Unit: mm



Weight: 0.26 g (typ.)



Rev.4.0



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